|                           | CONNECTING<br>INDUSTRIES®  | PC, Bannockb              | ourn, Illinois. A               | All rights reserved u ntions. | nder both     | This docume<br>level parts, th                                     | ent is a declarat<br>he declaration e | ion of the sencompasse          | substances<br>es all lowe | within the r<br>er level mate   | nanufacture<br>rials for wh | er listed ite<br>hich the ma    | em. Note: if<br>anufacturer l | the item is an as<br>nas engineering | ssembly with low responsibility. |
|---------------------------|--|---------------------------|---------------------------------|-------------------------------|---------------|--|---------------------------------------|---------------------------------|---------------------------|---------------------------------|-----------------------------|---------------------------------|-------------------------------|--------------------------------------|----------------------------------|
| 752-21.1                  | IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute |                           |                                 |                               | *             | * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materi |                                       |                                 |                           |                                 | als and Mfg Information     |                                 |                               |                                      |                                  |
| upplier                   | Information  |                           |                                 |                               |               |  |                                       |                                 |                           |                                 |                             |                                 |                               |                                      |                                  |
| Company name*             |  |                           |                                 | Company unique ID             |               |  | Unique ID Authority                   |                                 |                           |                                 |                             | Response Date*                  |                               |                                      |                                  |
| nsemi                     |  |                           |                                 |                               |               |  |                                       |                                 |                           |                                 |                             | 2024-09-26                      |                               |                                      |                                  |
| ontact Na                 | me   | Title - Contact           |                                 |                               | ]             | Phone - Contact*   |                                       |                                 |                           |                                 | Email - Contact*            |                                 |                               |                                      |                                  |
| Product-E                 | nv-Stewards  |                           | Product Enviro Compliance       |                               |               |  | NA                                    |                                 |                           |                                 |                             | Product-Env-Stewards@onsemi.com |                               |                                      |                                  |
| uthorized                 | Representative*  |                           | Title - Representative          |                               |               | ]  | Phone - Representative*               |                                 |                           |                                 | Email - Representative*     |                                 |                               |                                      |                                  |
| roduct-E                  | nv-Stewards  | Product Enviro Compliance |                                 |                               |               | NA   |                                       |                                 |                           | Product-Env-Stewards@onsemi.com |                             |                                 |                               |                                      |                                  |
|                           | Requester Item Number Mfr Item Number   1N459ATR   |                           | Number Mfr Item Name            |                               |               | ·  | Effective Date                        | Date Version Manufacturing Site |                           | ng Site                         | v                           | /eight*                         | UOM                           | Unit Type                            |                                  |
|                           |  |                           | TR                              | 200V LOW LEAKAG               |               |  | 2024-09-26 CN2                        |                                 |                           | 109.66989                       |                             | mg                              | Each                          |                                      |                                  |
| Ianufac                   | turing Proccess Informat   | tion                      |                                 |                               |               |  |                                       |                                 |                           |                                 |                             |                                 |                               |                                      |                                  |
| r                         | Terminal Plating / Grid Array Material   |                           | Ferminal Base Alloy J-STD-020 M |                               | J-STD-020 MSI | L Rating   | Peak Process Body Temperat            |                                 | Femperatu                 | ure Max Time at Peak Tempe      |                             | Temperatu                       | re Numbe                      | r of Reflow Cy                       | cles                             |
| Matte Tin (Sn) - annealed |  | CU Alloy NA               |                                 |                               | 0 C           |  | 30 seco                               |                                 | second                    | s <b>3</b>                      |                             |                                 |                               |                                      |                                  |
| omments                   |  |                           |                                 |                               |               |  |                                       |                                 |                           |                                 |                             |                                 |                               |                                      |                                  |
|                           |  |                           |                                 |                               |               |  |                                       |                                 |                           |                                 |                             |                                 |                               |                                      |                                  |
| or more ii                | nformation regarding material  | composition               | please refer to                 | o page 3                      |               |  |                                       |                                 |                           |                                 |                             |                                 |                               |                                      |                                  |

| RoHS Material Composition Declaration   |  |  |  | Declaration Type *  | Detailed  |
|---|--|--|--|---|---|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU   |  | mium (Cr6+), Polybrominated Biphenyls (  |  | dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-ethers)   |   |
| cadmium, hexavalentchromium, polybromina<br>contains a RoHS restricted substance inexcess<br>encompass all such components.Supplier cert<br>as of the date that Supplier completes this for<br>Company acknowledges that Supplier may ha<br>independently verified information provided<br>certification in this paragraph.If the Company | ted biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please in<br>ifies that it gathered the information it pr<br>m.Supplier acknowledges that Company<br>ve relied on informationprovided by oth<br>by others, Supplier agrees that, at a minir<br>and the Supplier enter into a written agr<br>source of the Supplier's liability and the | henyl ethers (each a "RoHS restricted subs<br>ndicate below which, if any, RoHS exempt<br>ovides in this form using appropriate meth<br>will rely on this certification in determinin<br>ers in completing this form, and that Suppl<br>num, itssuppliers have provided certificatio<br>eement with respect to the identified part,t<br>Company's remedies for issues that arise r | stance") in exce<br>ion you believe<br>ods to ensure i<br>g the compliar<br>ier may not ha<br>ons regarding t<br>he terms and co | ropean Union member states) of the part identifiess of the applicable quantity limit identified able may apply. If the part is an assembly with low is accuracy and that such information is true and ce of its products with European Union member independently verified such information. How heir contributions to the part, and those certifica onditions of that agreement, including any warra nation the Supplier provides in this form. In the | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>inty rights and/or remedies provided as part of |
| <b>RoHS Declaration *</b> 4 - Item(s  | ) does not contain RoHS restricted subst   | ances per the definition above except for se   | elected exempt   | ions Supplier Acceptance  | * Accepted  |
| Exemption: 7c-I Electrical and electronic c   | omponents containing lead in a glass o   | r ceramic other than dielectric ceramic  | in capacitors,   | e.g. piezoelectronic devices, or in a glass or c  | eramic matrix compound.   |
| Exemption List Version  | EL-2011/534/EU   |  |  |   |   |
| Declaration Signature   |  |  |  |   |   |
| Instructions: Complete all of the required Requester) and click on Submit Form to ha  |  |  | ice drop-dowi  | n. This will display the signature area. Digital  | ly sign the declaration (if required by the   |
| Supplier Digital Signature R  | astislav Drska   | Le   |  |   |   |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight   | Unit of Measure | Level    | Substance  | CAS              | Exempt | Weight | Unit of Measure |
|----------------------|----------|-----------------|----------|--|------------------|--------|--------|-----------------|
| CSS Wire             | 75.0     | mg              | Supplier | Iron (Fe)  | 7439-89-6        |        | 63.75  | mg              |
|                      |          |                 | Supplier | Copper (Cu)  | 7440-50-8        |        | 11.25  | mg              |
| Die                  | 0.024358 | mg              | Supplier | Titanium (Ti)  | 7440-32-6        |        | 0      | mg              |
|                      |          |                 | Supplier | Silver (Ag)  | 7440-22-4        |        | 0.0115 | mg              |
|                      |          |                 | Supplier | Silicon (Si)   | 7440-21-3        |        | 0.0127 | mg              |
|                      |          |                 | В        | Nickel (Ni)  | 7440-02-0        |        | 0.0001 | mg              |
| Dumet Wire           | 8.5      | mg              | Supplier | Manganese (Mn)   | 7439-96-5        |        | 0.085  | mg              |
|                      |          |                 | Supplier | Silicon (Si)   | 7440-21-3        |        | 0.0595 | mg              |
|                      |          |                 | В        | Nickel (Ni)  | 7440-02-0        |        | 2.6775 | mg              |
|                      |          |                 | Supplier | Iron (Fe)  | 7439-89-6        |        | 3.6805 | mg              |
|                      |          |                 | Supplier | Copper (Cu)  | 7440-50-8        |        | 1.9975 | mg              |
| Glass Encapsulation  | 23.5     | mg              | Supplier | Boron Trioxide (B2O3)  | 1303-86-2        |        | 0.705  | mg              |
|                      |          |                 | А        | Lead Oxide (PbO)   | 1317-36-8        | 7c     | 14.382 | mg              |
|                      |          |                 | В        | Antimony Trioxide (Sb2O3)  | 1309-64-4        |        | 0.0118 | mg              |
|                      |          |                 | Supplier | Potassium Monoxide (K2O)   | 12136-45-7       |        | 0.8813 | mg              |
|                      |          |                 | Supplier | Silica Crystalline (SiO2)  | 14808-60-7       |        | 7.52   | mg              |
| Marking Ink          | 0.01953  | mg              | Supplier | Titanium Dioxide (TiO2)  | 13463-67-7       |        | 0.004  | mg              |
|                      |          |                 | Supplier | Formaldehyde, polymer with 4,4-(1-<br>methylethylidene)bisphenol | 25085-75-0       |        | 0.0052 | mg              |
|                      |          |                 | Supplier | Proprietary  | Proprietary Data |        | 0.0009 | mg              |
|                      |          |                 | Supplier | Silica Amorphous (SiO2)  | 7631-86-9        |        | 0.001  | mg              |
|                      |          |                 | Supplier | Carbon Black (C)   | 1333-86-4        |        | 0.0013 | mg              |
|                      |          |                 | Supplier | Diethylene glycol 2-ethyhexyl-ether                              | 1559-36-0        |        | 0.0025 | mg              |
|                      |          |                 | Supplier | Amino Resin  | 68002-20-0       |        | 0.0033 | mg              |
|                      |          |                 | Supplier | 2,2,4-Trimethyl-1,3-pentanediol di is<br>Obutyrate               | 6846-50-0        |        | 0.0013 | mg              |
| Plating              | 2.626    | mg              | Supplier | Tin (Sn)   | 7440-31-5        |        | 2.626  | mg              |